捷多邦,专业PCB打样上0874不止088,出生287, TL288 JFET-INPUT OPERATIONAL AMPLIFIERS

SLOS082A - D2484, MARCH 1979 - REVISED JANUARY 1993

- Low Input Offset Voltage . . . 0.5 mV Max
- Low Power Consumption
- Wide Common-Mode and Differential Voltage Ranges
- Low Input Bias and Offset Currents
- High Input Impedance . . . JFET-Input Stage
- Internal Frequency Compensation
- Latch-Up-Free Operation
- High Slew Rate . . . 18 V/μs Typ
- Low Total Harmonic Distortion 0.003% Typ

description

These JFET-input operational amplifiers incorporate well-matched high-voltage JFET and bipolar transistors in a monolithic integrated circuit. They feature low input offset voltage, high slew rate, low input bias and offset currents, and low temperature coefficient of input offset voltage. Offset-voltage adjustment is provided for the TL087 and TL088.

The C-suffix devices are characterized for operation from 0°C to 70°C, and the I-suffix devices are characterized for operation from –40°C to 85°C. The M-suffix devices are characterized for operation over the full military temperature range of –55°C to 125°C.

AVAILABLE OPTIONS

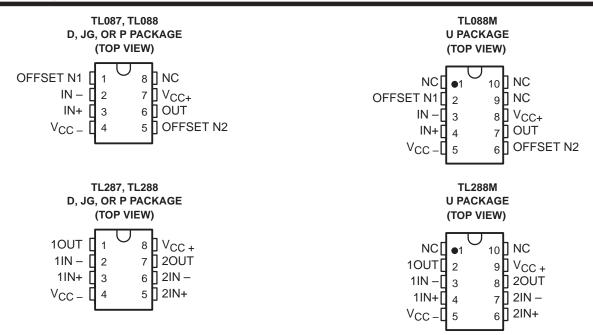
		Via may	PACKAGE								
TA	TYPE	V _{IO} max AT 25°C	SMALL OUTLINE (D)	CERAMIC DIP (JG)	PLASTIC DIP (P)	FLAT (U)					
0°C to	Single	0.5 mV 1 mV	TL087CD TL088CD	TL087CJG TL088CJG	TL087CP TL088CP						
70°C	Dual	0.5 mV 1 mV	TL287CD TL288CD	TL287CJG TL288CJG	TL287CP TL288CP	-7 57					
−40°C to	Single	0.5 mV 1 mV	TL087ID TL088ID	TL087IJG TL088IJG	TL087IP TL088IP	TOTAL					
85°C	Dual	0.5 mV 1 mV	TL287ID TL288ID	TL287IJG TL288IJG	TL287IP TL288IP	1.0750					
−55°C to	Single	1 mV	平元間 6	TL088MJG		TL088MU					
125°C	Dual	1 mV	SC.COM	TL288MJG		TL288MU					

The D package is available taped and reeled. Add the suffix R to the device type (e.g., TL087CDR).



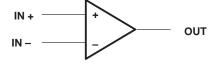


SLOS082A - D2484, MARCH 1979 - REVISED JANUARY 1993



symbol (each amplifier)

NC - No internal connection



SLOS082A - D2484, MARCH 1979 - REVISED JANUARY 1993

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

		TL088M TL288M	TL087I TL088I TL287I TL288I	TL087C TL088C TL287C TL288C	UNIT		
Supply voltage, VCC+ (see Note 1)		18	18	18	V		
Supply voltage, V _{CC} - (see Note 1)		-18	-18	-18	V		
Differential input voltage (see Note 2)		±30	±30	±30	V		
Input voltage (see Notes 1 and 3)		±15	±15	±15	V		
Input current, I _I (each Input)	Input current, I _I (each Input)				mA		
Output current, IO (each output)		±80	±80 ±80 ±80		mA		
Total V _{CC} + terminal current		160	160 160		mA		
Total V _{CC} - terminal current		-160	-160 -160		mA		
Duration of output short circuit (see Note 4)		unlimited	unlimited	unlimited			
Continuous total dissipation		See Dissipation Rating Table					
Operating free-air temperature range		-55 to 125	-55 to 125 -25 to 85		°C		
Storage temperature range	-65 to 150 -65 to 150		-65 to 150	°C			
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds	JG or U package	300	300	300	°C		
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	D or P package		260	260	°C		

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-}.
 - 2. Differential voltages are at the noninverting input terminal with respect to the inverting input terminal.
 - 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
 - 4. The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T _{A =} 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW	N/A
JG	1050 mW	8.4 mW/°C	672 mW	546 mW	210 mW
Р	1000 mW	8.0 mW/°C	640 mW	520 mW	N/A
U	675 mW	5.4 mW/°C	432 mW	351 mW	135 mW

recommended operating conditions

			C-SUFFIX			I-SUFFIX			M-SUFFIX		
		MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		±5		±5	±5		±5	±5		±15	V
Common mode input voltage V/o	$V_{CC\pm} = \pm 5 \text{ V}$	-1		4	-1		4	-1		4	V
Common-mode input voltage, V _{IC}	$V_{CC\pm} = \pm 15 \text{ V}$	-11		11	-11		11	-11		11	V
Input voltage, V _I	$V_{CC\pm} = \pm 5 \text{ V}$	-1		4	-1		4	-1		4	V
Imput voltage, v	$V_{CC\pm} = \pm 15 \text{ V}$	-11		11	-11		11	-11		11	V
Operating free-air temperature, TA		0		70	-40		85	-55		125	°C



SLOS082A - D2484, MARCH 1979 - REVISED JANUARY 1993

±15 V

II

electrical characteristics, V_{CC±}

μV/°C \/m/\ MHz F Z N βĄ Ν ρĄ Ν 뜅 g mA > > C 100 MAX 0.5 1.5 200 TL287C TL288C TL087C TL088C 1012 TYP ∞ 2 က 30 0.1 105 93 66 0.1 27 /CC-+4 VCC+-4 Z 24 24 20 50 25 80 80 9 MAX 2 က 100 0.5 200 20 TYP 1012 TL0871 TL0881 TL2871 TL2881 ∞ 2 က 3 105 93 66 0.1 0.1 27 /CC-+4 9 VCC+-4 N 24 24 20 20 25 80 80 MAX က 9 25 100 TL088M TL288M 1012 TYP 9 2 က 26 0.1 30 105 93 66 27 /CC-+4 9 VCC+-4 N 24 24 20 50 25 80 80 $T_A = 25^{\circ}C$ to MAX TL088, TL288 TL087, TL287 TL088, TL288 TL087, TL287 $V_0 = \pm 10 \text{ V},$ TEST CONDITIONS √0 = ±10 V $R_L = 10 \text{ k}\Omega$ $R_L \ge 10 \text{ k}\Omega$ $R_L \ge 2 k\Omega$ VIC = VICR min, TA = 25°C $V_{O} = 0 V$ $^{V}O = 0 V,$ $V_0 = 0 V$ $V_{CC\pm} = \pm 9 \text{ V to} \pm 15 \text{ V}$ T_A = full range T_A = full range T_A = full range FA = full range T_A = full range $T_{A} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$ $RS = 50 \Omega$, $RS = 50 \Omega,$ $T_A = 25^{\circ}C$ $R_L \ge 2 k\Omega$, $R_S = 50 \Omega$ Rs = 50Ω , $R_S = 50 \Omega$, $T_A = 25^{\circ}C$ T_A = 25°C $R_L \ge 2 k\Omega$, T_A = 25°C $T_A = 25^{\circ}C$ T_A = 25°C $T_A = 25^{\circ}C$ T_A = 25°C $V_{O} = 0$, No load, $V_0 = 0$ Common-mode rejection Supply voltage rejection Maximum-peak-to-peak Large-signal differential Temperature coefficient of input offset voltage output voltage swing Unity-gain bandwidth Common-mode input voltage amplification ratio (∆VCC±/∆VIO) Input offset voltage Input offset current Input bias current Input resistance **PARAMETER** Supply current voltage range (per amplifier) ratio VO(PP) CMRR $_{\alpha}^{\text{VIO}}$ kSVR VICR AVD <u>0</u>/

‡ Input bias currents of a FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive. Pulse techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible. † All characteristics are measured under open-loop conditions with zero common-mode input voltage unless otherwise specified. Full range for TA is -55°C to 125°C for TL_88M; -40°C to 85°C for TL_8_I; and 0°C to 70°C for TL_8_C.

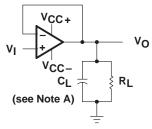
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<u>_</u> <u>@</u>

operating characteristics $V_{CC} = \pm 15$ V, $T_A = 25^{\circ}C$

PARAMETER		TEST C	TL088M, TL288M			TL087I, TL087C TL088I, TL088C			UNIT	
				MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain	V _I = 10 V, C _L = 100 pF,	$R_L = 2 k\Omega$, $A_{VD} = 1$		18		8	18		V/μs
t _r	Rise time	V _I = 20 mV,	$R_L = 2 k\Omega$,		55			55		ns
	Overshoot factor	$C_L = 100 pF$,	$A_{VD} = 1$		25%			25%		
٧n	Equivalent input noise voltage	$R_S = 100 \Omega$,	f = 1 kHz		19			19		nV/√ Hz

PARAMETER MEASUREMENT INFORMATION



NOTE A: C_L includes fixture capacitance.

Figure 1. Slew Rate, Rise/Fall Time, and Overshoot Test Circuit

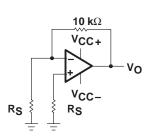


Figure 3. Noise Voltage Test Circuit

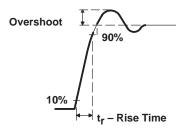
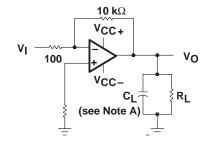


Figure 2. Rise Time and Overshoot Waveform



NOTE A: C_L includes fixture capacitance.

Figure 4. Unity-Gain Brandwidth and Phase Margin Test Circuit

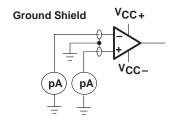


Figure 5. Input Bias and Offset Current Test Circuit



SLOS082A - D2484, MARCH 1979 - REVISED JANUARY 1993

typical values

Typical values as presented in this data sheet represent the median (50% point) of device parametric performance.

input bias and offset current

At the picoamp bias current level typical of these JFET operational amplifiers, accurate measurement of the bias current becomes difficult. Not only does this measurement require a picoammeter, but test socket leakages can easily exceed the actual device bias currents. To accurately measure these small currents, Texas Instruments uses a two-step process. The socket leakage is measured using picoammeters with bias voltages applied, but with no device in the socket. The device is then inserted in the socket and a second test that measures both the socket leakage and the device input bias current is performed. The two measurements are then subtracted algebraically to determine the bias current of the device.



SLOS082A - D2484, MARCH 1979 - REVISED JANUARY 1993

TYPICAL CHARACTERISTICS

table of graphs

			FIGURE
α VIO	Temperature coefficient of input offset voltage	Distribution	6, 7
IIO	Input offset current	vs Temperature	8
I _{IB}	Input bias current	vs V _{IC} vs Temperature	9 8
VI	Common-mode input voltage range limits	vs V _{CC} vs Temperature	10 11
V _{ID}	Differential input voltage	vs Output voltage	12
Vом	Maximum peak output voltage swing	vs V _{CC} vs Output current vs Frequency vs Temperature	13 17 14, 15, 16 18
AVD	Differential voltage amplification	vs R _L vs Frequency vs Temperature	19 20 21
z _O	Output impedance	vs Frequency	24
CMRR	Common-mode rejection ratio	vs Frequency vs Temperature	22 23
ksvr	Supply-voltage rejection ratio	vs Temperature	25
los	Short-circuit output current	vs V _{CC} vs Time vs Temperature	26 27 28
Icc	Supply current	vs V _{CC} vs Temperature	29 30
SR	Slew rate	vs R _L vs Temperature	31 32
	Overshoot factor	vs C _L	33
V _n	Equivalent input noise voltage	vs Frequency	34
THD	Total harmonic distortion	vs Frequency	35
B ₁	Unity-gain bandwidth	vs V _{CC} vs Temperature	36 37
φm	Phase margin	vs V _{CC} vs C _L vs Temperature	38 39 40
	Phase shift	vs Frequency	20
	Pulse response	Small-signal Large-signal	41 42

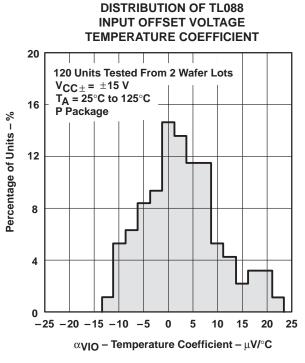


Figure 6

INPUT BIAS CURRENT AND INPUT OFFSET CURRENT vs FREE-AIR TEMPERATURE

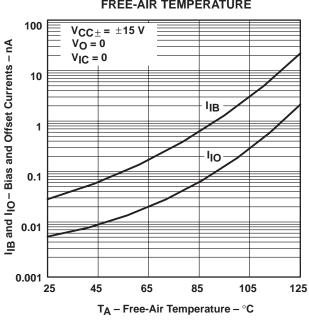


Figure 8

DISTRIBUTION OF TL288 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT

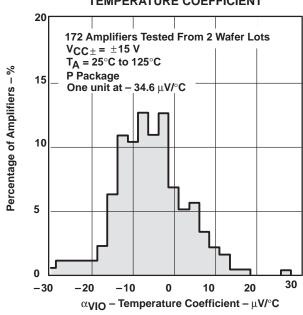
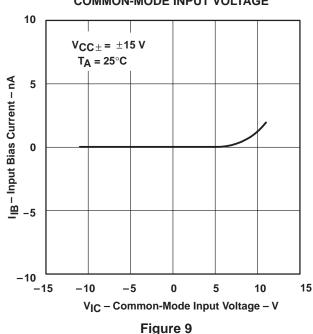


Figure 7

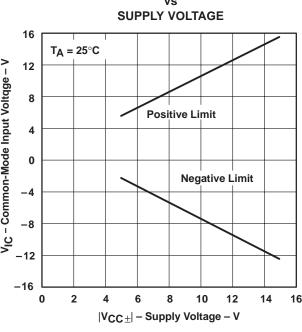
INPUT BIAS CURRENT vs COMMON-MODE INPUT VOLTAGE



[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



COMMON-MODE INPUT VOLTAGE RANGE LIMITS SUPPLY VOLTAGE 16 T_A = 25°C V_{IC} - Common-Mode Input Voltage - V 12 8 **Positive Limit** 4 0 **Negative Limit** -4 -8 -12 -16 16 0 2 8 10 12 14 $|V_{CC\pm}|$ – Supply Voltage – V



15

10

5

0

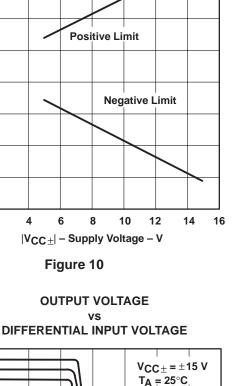
-5

-10

-15

-400

Vo - Output Voltage - V



 $R_L = 600 \Omega$ $R_L = 1 k\Omega$ $R_L = 2 k\Omega$ $R_L = 10 \text{ k}\Omega$

200

Figure 12

0

V_{ID} - Differential Input Voltage - μV

-200

COMMON-MODE INPUT VOLTAGE RANGE LIMITS FREE-AIR TEMPERATURE

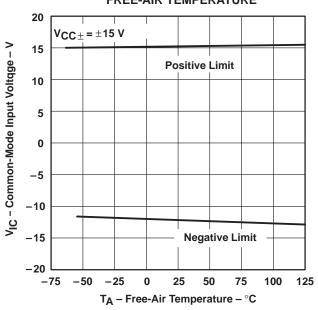


Figure 11

MAXIMUM PEAK OUTPUT VOLTAGE

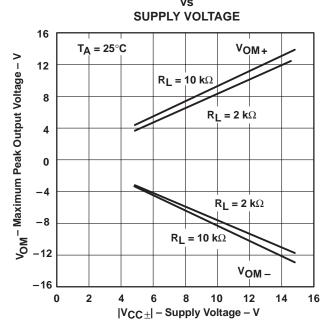


Figure 13

400



[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE

FREQUENCY 30 VO(PP) - Maximum Peak-to-Peak Output Voltage - V $R_L = 2 k\Omega$ $V_{CC\pm} = \pm 15 V$ 25 20 15 T_A = 125°C 10 $V_{CC\pm} = \pm 5 \text{ V}$ $T_A = -55^{\circ}C$ 5 10 M 100 k 1 M 10 k f - Frequency - Hz

Figure 14

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE FREQUENCY 30 VO(PP) - Maximum Peak-to-Peak Output Voltage - V $R_L = 2 k\Omega$ $T_A = 25^{\circ}C$ $V_{CC\pm} = \pm 15 \text{ V}$ 25 20 15 10 V_{CC±} = ±5 V 5 10 k 100 k 10 M f - Frequency - Hz

Figure 15

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE

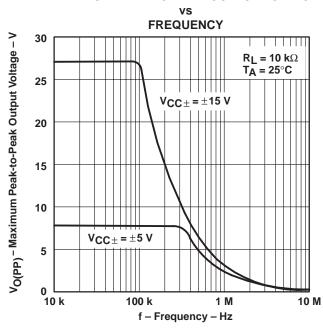


Figure 16

MAXIMUM PEAK OUTPUT VOLTAGE

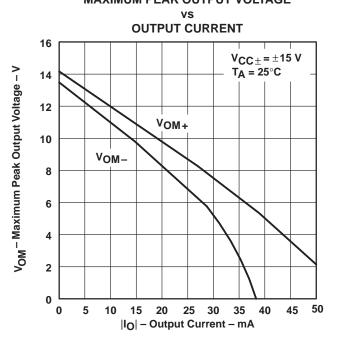


Figure 17

[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



MAXIMUM PEAK OUTPUT VOLTAGE FREE-AIR TEMPERATURE 16 $R_L = 10 \text{ k}\Omega$ V_{OM} – Maximum Peak Output Voltage – V 12 VOM+ $R_L = 2 k\Omega$ 8 4 $V_{CC\pm} = \pm 15 V$ 0 -4 -8 NOM- $R_L = 2 k\Omega$ -12 $R_L = 10 \text{ k}\Omega$ -16 -75 -50 25 50 75 100 125 T_A – Free-Air Temperature – $^{\circ}C$

Figure 18

LARGE-SIGNAL VOLTAGE AMPLIFICATION LOAD RESISTANCE 250 A_{VD} – Differential Voltage Amplification – V/m V $V_0 = \pm 1 V$ $T_A = 25^{\circ}C$ 200 $V_{CC\pm} = \pm 15 \text{ V}$ 150 $V_{CC\pm} = \pm 5 V$ 100 50 0 0.4 10 40 100 R_L – Load Resistance – $k\Omega$

Figure 19

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE SHIFT

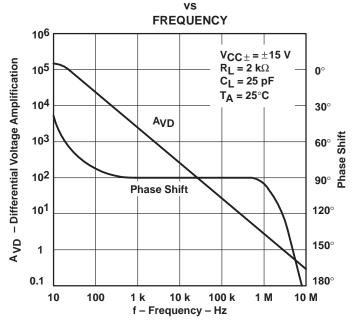
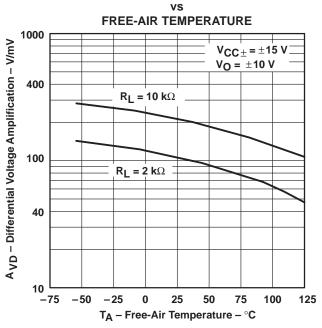


Figure 20

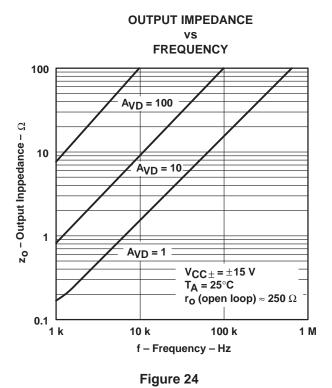
LARGE-SIGNAL VOLTAGE AMPLIFICATION



[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

COMMON-MODE REJECTION RATIO FREQUENCY 100 CMRR - Common-Mode Rejection Ratio - dB $V_{CC\pm} = \pm 15 V$ 90 $T_A = 25^{\circ}C$ 80 70 60 50 40 30 20 10 0 10 100 10 k 100 k 1 M 10 M f - Frequency - Hz

Figure 22



COMMON-MODE REJECTION RATIO vs

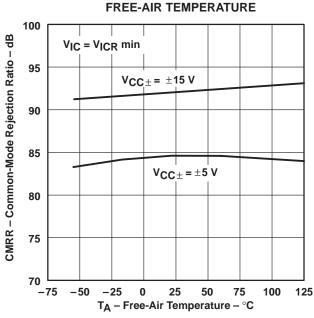
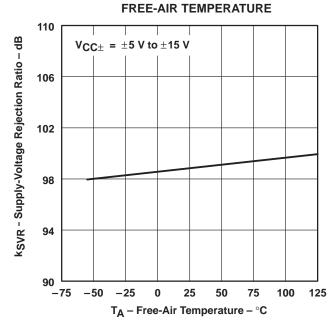


Figure 23

SUPPLY-VOLTAGE REJECTION RATIO vs

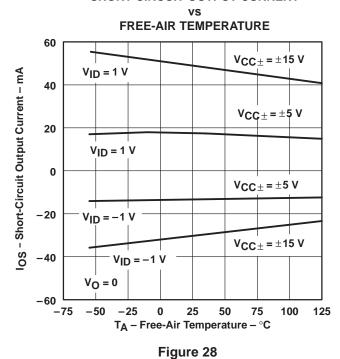


[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



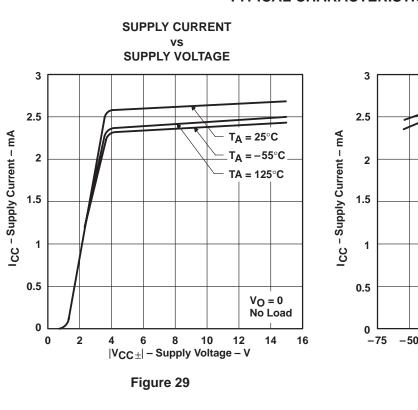
SHORT-CIRCUIT OUTPUT CURRENT SHORT-CIRCUIT OUTPUT CURRENT SUPPLY VOLTAGE TIME 60 60 $V_O = 0$ $V_{ID} = 1 V$ Ios - Short-Circuit Output Current - mA IOS - Short-Circuit Output Current - mA T_A = 25°C 40 40 V_{ID} = 1 V 20 20 0 0 -20 -20 $V_{ID} = -1 V$ $V_{ID} = -1 V$ $V_{CC\pm} = \pm 15 V$ -40 -40 T_A = 25°C -60 -60 0 10 20 30 40 60 12 14 16 50 Time - Seconds |V_{CC±}| - Supply Voltage - V Figure 26 Figure 27

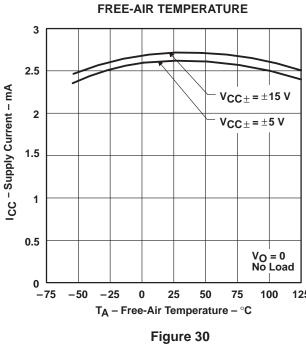
SHORT-CIRCUIT OUTPUT CURRENT



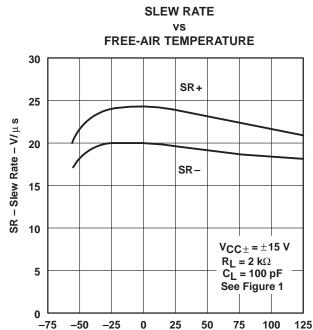
[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.







SUPPLY CURRENT



T_A - Free-Air Temperature - °C

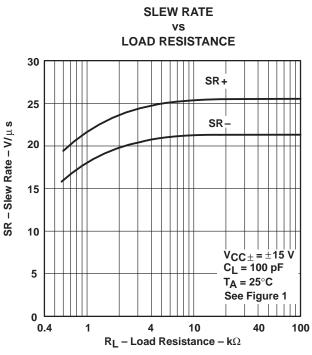


Figure 31

† Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



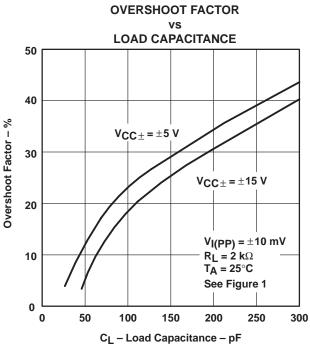
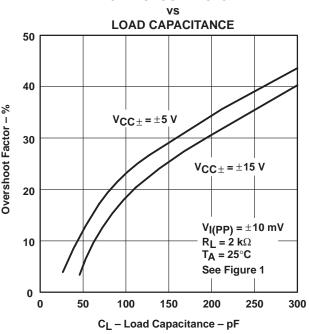
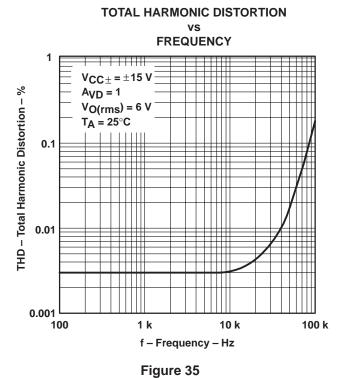


Figure 33





EQUIVALENT INPUT NOISE VOLTAGE

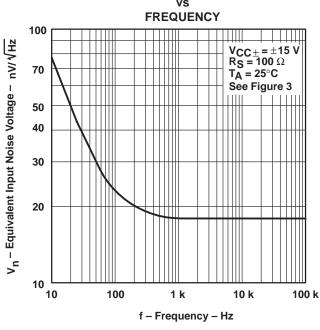
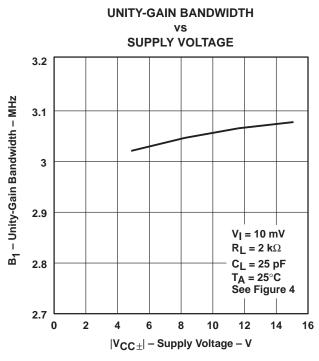


Figure 34



[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



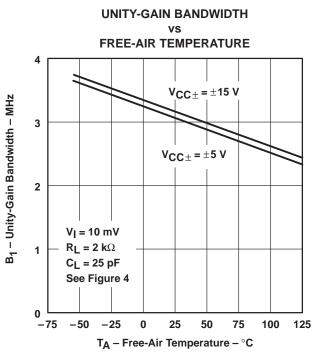
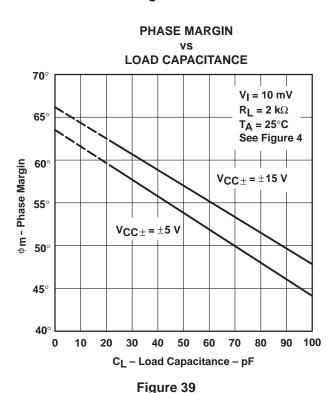


Figure 37



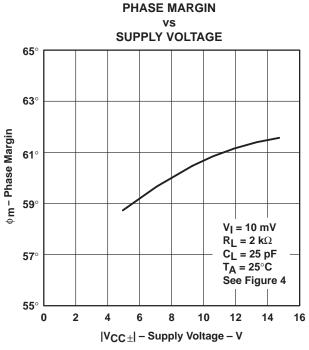


Figure 38

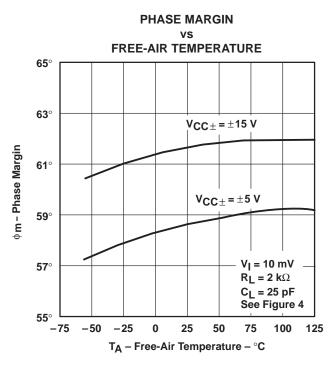


Figure 40

[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS

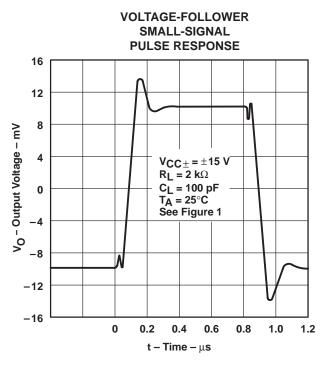


Figure 41

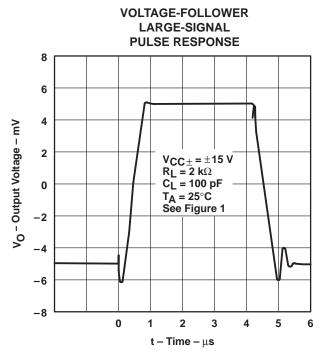


Figure 42

TYPICAL APPLICATION DATA

output characteristics

All operating characteristics are specified with 100-pF load capacitance. These amplifiers will drive higher capacitive loads; however, as the load capacitance increases, the resulting response pole occurs at lower frequencies, thereby causing ringing, peaking, or even oscillation. The value of the load capacitance at which oscillation occurs varies with production lots. If an application appears to be sensitive to oscillation due to load capacitance, adding a small resistance in series with the load should alleviate the problem. Capacitive loads of 1000 pF and larger may be driven if enough resistance is added in series with the output (see Figure 43).

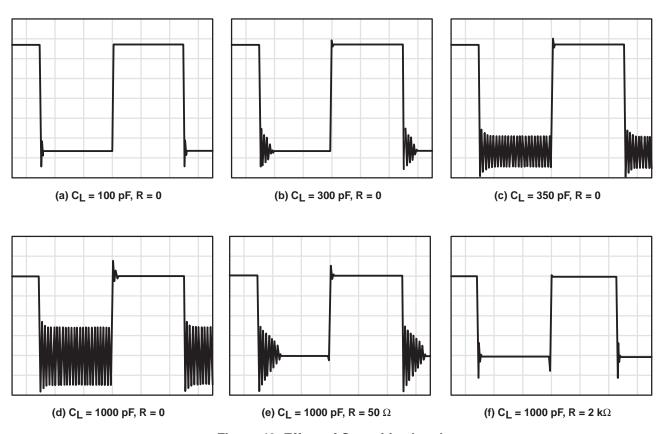


Figure 43. Effect of Capacitive Loads

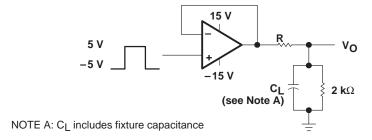


Figure 44. Test Circuit for Output Characteristics



SLOS082A - D2484, MARCH 1979 - REVISED JANUARY 1993

TYPICAL APPLICATION DATA

input characteristics

These amplifiers are specified with a minimum and a maximum input voltage that, if exceeded at either input, could cause the device to malfunction.

Because of the extremely high input impedance and resulting low bias current requirements, these amplifiers are well suited for low-level signal processing; however, leakage currents on printed circuit boards and sockets can easily exceed bias current requirements and cause degradation in system performance. It is good practice to include guard rings around inputs (see Figure 45). These guards should be driven from a low-impedance source at the same voltage level as the common-mode input.

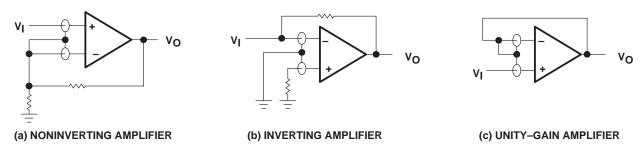


Figure 45. Use of Guard Rings

noise performance

The noise specifications in op amp circuits are greatly dependent on the current in the first-stage differential amplifier. The low input bias current requirments of these amplifiers result in a very low current noise. This feature makes the devices especially favorable over bipolar devices when using values of circuit impedance greater than 50 k Ω .



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